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Pre Amended A

Revised

9/18/02

ATTORNEY DOCKET NO: 70357

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : FINN et al.
PCT No : PCT/DE00/01396
Filed : November 5, 2001
For : CHIP CARRIER FOR...
Dated : November 2, 2001

Hon. Commissioner of Patents
and Trademarks
Washington, D.C. 20231

PRELIMINARY AMENDMENT

Prior to initial examination, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please replace the specification originally filed, with the enclosed substitute specification. A marked up copy of the original specification is attached. Applicant states that no new matter has been added.

IN THE CLAIMS:

Please rewrite the claims as follows:

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1. (AMENDED) A chip carrier for forming a chip module, the chip carrier comprising:
- 4 a substrate formed by a carrier film; and
- connection leads arranged on the substrate, said connection leads comprising stripes and extend parallel over the substrate, said connection leads comprising electrically conductive